



TE Internal #: 1473149-1  
 Double Data Rate (DDR), Stack Height 5.2 mm [.205 in], Right Angle  
 Module Orientation, 200 Position, .6 mm [.024 in] Centerline, SO  
 DIMM Sockets

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Connectors > Socket Connectors > Memory Sockets > SO DIMM Sockets > DDR2 SO DIMM Sockets



DRAM Type: **Double Data Rate (DDR)**  
 Stack Height: **5.2 mm [.205 in]**  
 Module Orientation: **Right Angle**  
 Number of Positions: **200**  
 Centerline (Pitch): **.6 mm [.024 in]**

[All DDR2 SO DIMM Sockets \(30\)](#)

## Features

### Product Type Features

Connector System	Cable-to-Board
Connector & Contact Terminates To	Printed Circuit Board
DRAM Type	Double Data Rate (DDR)

### Configuration Features

Number of Bays	2
Number of Keys	1
Number of Rows	2
Module Orientation	Right Angle
Number of Positions	200

### Electrical Characteristics

DRAM Voltage	2.5 V
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### Signal Characteristics

SGRAM Voltage	2.5 V
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### Body Features

Ejector Location	Both Ends
Latch Material	Stainless Steel
Latch Plating Material	Tin



Module Key Type	SGRAM
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Ejector Type	Locking
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Connector Profile	Standard
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#### Contact Features

Memory Socket Type	Memory Card
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PCB Contact Termination Area Plating Material	Gold Flash
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Contact Base Material	Copper Alloy
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Contact Current Rating (Max)	.5 A
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Contact Mating Area Plating Material	Gold Flash
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#### Termination Features

Insertion Style	Cam-In
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Termination Method to PCB	Surface Mount
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#### Mechanical Attachment

Mating Alignment Type	Reverse Keying
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PCB Mount Retention	With
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PCB Mount Retention Type	Solder Peg
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Connector Mounting Type	Board Mount
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#### Housing Features

Housing Material	High Temperature Thermoplastic
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Housing Color	Black
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Centerline (Pitch)	.6 mm [.024 in]
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#### Dimensions

Stack Height	5.2 mm [.205 in]
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Row-to-Row Spacing	6.2 mm [.244 in]
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#### Usage Conditions

Operating Temperature Range	-55 – 85 °C [-67 – 185 °F]
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#### Operation/Application

Circuit Application	Power
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#### Industry Standards

UL Flammability Rating	UL 94V-0
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#### Packaging Features



Packaging Quantity	20
Packaging Method	Semi-Hard Tray Assembly, Tray

### Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JAN 2024 (240) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

### Compatible Parts



### Customers Also Bought



TE Part #1-2199230-6  
M.2 0.5PITCH 4.2H KEY M 30U AU



TE Part #1-1721150-0  
ORWH-SH-105D1F,000



TE Part #1623401-1  
CRG0805 ZEROHM



TE Part #42460-2  
FF 250 TAB 18-14AWG TPBR



TE Part #1775862-2  
mSATA/mini PCI-E 5.2H Type I G/F



TE Part #2-2176331-7  
CRGP 2512 1K5 1%



TE Part #2-2176331-3  
CRGP 2512 680R 1%



TE Part #185534-2  
Signal Header



TE Part #1776293-8  
TSB23008DS=EUROPA TERM BLK,  
8MM

## Documents

### Product Drawings

[SEMI-HARD TRAY ASSY DDR 200P 5](#)

English

### CAD Files

Customer View Model

[ENG\\_CVM\\_CVM\\_1473149-1\\_K2.2d\\_dxf.zip](#)

English

### 3D PDF

3D

Customer View Model

[ENG\\_CVM\\_CVM\\_1473149-1\\_K2.3d\\_igs.zip](#)

English

Customer View Model

[ENG\\_CVM\\_CVM\\_1473149-1\\_K2.3d\\_stp.zip](#)

English

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## Product Specifications



## Product Specification

English